

FEATURES



PS5 Compatible Heatsink

Sleek dual finish aluminum heatsink designed to fit the PS5 ensures maximum performance across all platforms.



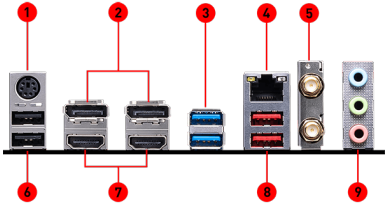
3D NAND

The 3D NAND flash technology brings dense storage in a compact design and allows storage capacities up to 4TB.

SPECIFICATIONS

Model Name	B760M GAMING PLUS WIFI
CPU Support	Support Intel® Core™ 14th/ 13th/ 12th Gen Processors, Intel® Pentium® Gold and Celeron® Processors
CPU Socket	LGA 1700
Chipset	Intel® B760 Chipset
Expansion Slots	2x PCIe 4.0 x16 slots, 1x PCIe 3.0 x1 slot
Display Interface	Support 4K@60Hz as specified in HDMI™ 2.1, DisplayPort 1.4 – Requires Processor Graphics
Memory Support	4 DIMMs, Dual Channel DDR5-6800+MHz(OC)
Storage	2x M.2 Gen4 x4 64Gbps slots, 4x SATA 6Gbps ports
USB ports	2x USB 3.2 Gen 2 10Gbps (2 Type-A), 7x USB 3.2 Gen 1 5Gbps (6 Type-A + 1 Type-C), 6x USB 2.0
LAN	Realtek® RTL8125BG 2.5Gbps LAN
WiFi / BT	Intel® Wi-Fi 6E, Bluetooth 5.3
Audio	8-Channel (7.1) HD Audio with Audio Boost

CONNECTIONS



- | | |
|---------------------------------|----------------------------------|
| 1. Keyboard / Mouse | 2. Display Port |
| 3. USB 3.2 Gen 1 5Gbps (Type-A) | 4. 2.5G LAN |
| 5. Wi-Fi / Bluetooth | 6. USB 2.0 (Type-A) |
| 7. HDMI™ | 8. USB 3.2 Gen 2 10Gbps (Type-A) |
| 9. Audio Connectors | |